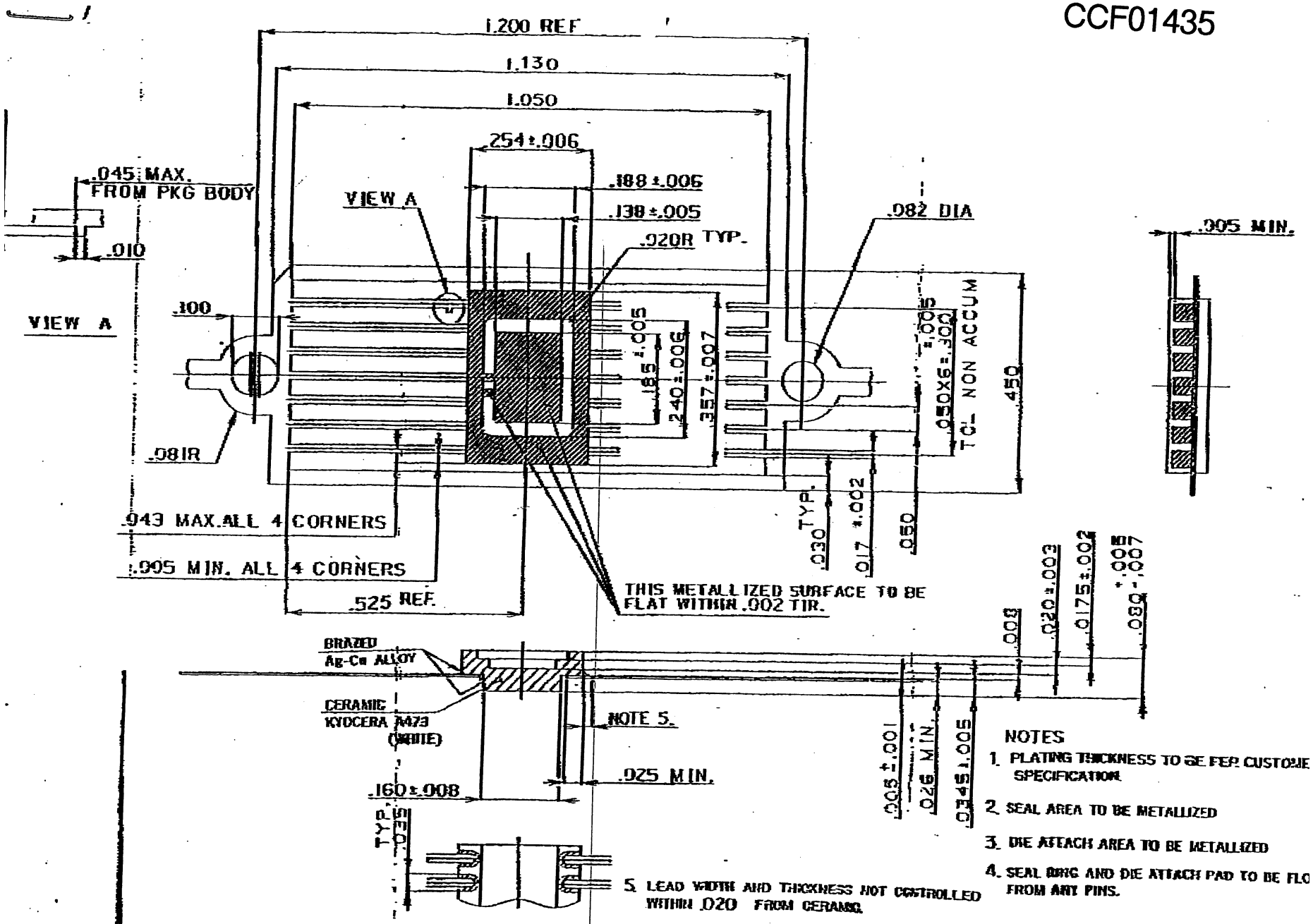
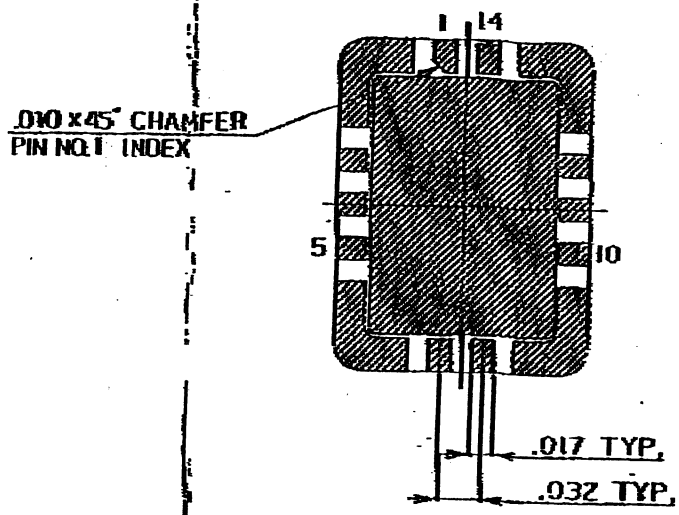
CCF01435


1.200 REF
1.130
1.050
.254±.006
.188±.006
.138±.005
.045 MAX. FROM PKG BODY
.010
VIEW A
.920R TYP.
.082 DIA
.005 MIN.
.100
VIEW A
.185±.005
.240±.006
.357±.007
.050X6=.300 ±.005
TCL NON ACCUM
.450
.081R
.943 MAX.ALL 4 CORNERS
.995 MIN. ALL 4 CORNERS
.525 REF.
.030 TYP.
.017±.002
.050
THIS METALLIZED SURFACE TO BE FLAT WITHIN .002 TIR.
.003
.020±.003
.0175±.002
.080 +.008 -.007
BRAZED Ag-Cu ALLOY
CERAMIC KYOCERA A473 (WHITE)
NOTE 5.
.025 MIN.
.160±.008
.030 TYP.
.005±.001
.026 MIN.
.0345±.005
5. LEAD WIDTH AND THICKNESS NOT CONTROLLED WITHIN .020 FROM CERAMIC.
NOTES
1. PLATING THICKNESS TO BE PER CUSTOME SPECIFICATION
2. SEAL AREA TO BE METALLIZED
3. DIE ATTACH AREA TO BE METALLIZED
4. SEAL RING AND DIE ATTACH PAD TO BE FLO FROM ANY PINS.
FW014T370-1
NAME 14 LEAD FLAT PACKAGE
SCALE 5 : 1
MATERIAL AS INDICATED
TOLERANCES UNLESS OTHERWISE SPECIFIED ±.005
DRAWN
APPROVED

CCF01435



BONDING PATTERN

NAME: 14 LEAD FLAT PACKAGE	TOLERANCES: UNLESS OTHERWISE SPECIFIED	DRAWN: A. Ishiyama	CHECKED
SCALE: 10 : 1	MATERIAL:	APPROVED:	DATE: MAY.0
KYOCERA CORPORATION KYOTO JAPAN		DWG.NO. KD-F87370	